

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



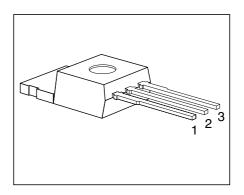






### **Features**

- N channel
- Logic level
- Enhancement mode
- Temperature sensor with thyristor characteristicThe drain pin is electrically shorted to the tab



Pin	1	2	3
	G	D	S

Туре	$V_{ t DS}$	$I_{ extsf{D}}$	$R_{DS(on)}$	Package	Ordering Code
BTS 121A	100 V	22 A	0.1 Ω	TO-220AB	C67078-S5010-A2

## **Maximum Ratings**

Parameter	Symbol	Values	Unit
Drain-source voltage	$V_{ t DS}$	100	V
Drain-gate voltage, $R_{GS}$ = 20 kΩ	$V_{DGR}$	100	
Gate-source voltage	$V_{GS}$	± 10	
Continuous drain current, $T_{\rm C}$ = 25 °C	$I_{D}$	22	Α
ISO drain current $T_{\rm C}$ = 85 °C, $V_{\rm DS}$ = 10 V, $V_{\rm DS}$ = 0.5 V	$I_{ extsf{D-ISO}}$	3.5	
Pulsed drain current, $T_{\rm C}$ = 25 °C	$I_{D}$ puls	88	
Short circuit current, $T_{\rm j} = -55 \dots + 150 ^{\circ}\text{C}$	$I_{ m SC}$	68	
Short circuit dissipation, $T_{\rm j}$ = $-55$ + 150 °C $V_{\rm DS} \le 50$ V / $V_{\rm DS} \le 15$ V	$P_{SCmax}$	800 / 1000	W
Power dissipation	$P_{tot}$	95	
Operating and storage temperature range	$T_{\rm j},T_{\rm stg}$	- 55 + 150	°C
DIN humidity category, DIN 40 040	_	E	_
IEC climatic category, DIN IEC 68-1	_	55/150/56	
Thermal resistance Chip-case Chip-case	R <sub>th JC</sub>	≤ 1.32	K/W
Chip-ambient	$R_{thJA}$	≤ 75	

1 04.97



## **Electrical Characteristics**

at  $T_{\rm j}$  = 25 °C, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Static Characteristics					
Drain-source breakdown voltage $V_{\rm GS}$ = 0, $I_{\rm D}$ = 0.25 mA	$V_{(BR)DSS}$	100	_	_	V
Gate threshold voltage $V_{\rm GS} = V_{\rm DS}, I_{\rm D} = 1  {\rm mA}$	$V_{GS(th)}$	1.5	2.0	2.5	
Zero gate voltage drain current $V_{\rm GS}$ = 0 V, $V_{\rm DS}$ = 100	$I_{ extsf{DSS}}$				μА
$T_{\rm j}$ = 25 °C $T_{\rm j}$ = 125 °C		_	0.1 10	1.0 100	
Gate-source leakage current $V_{\rm GS} = \pm  20   {\rm V},  V_{\rm DS} = 0$	$I_{GSS}$				
$T_{\mathrm{j}}$ = 25 °C $T_{\mathrm{j}}$ = 150 °C		_	10 2	100 4	nA μA
Drain-source on-state resistance $V_{\rm GS}$ = 4.5 V, $I_{\rm D}$ = 9.5 A	$R_{DS(on)}$	_	0.085	0.1	Ω
Dynamic Characteristics					
Forward transconductance $V_{\rm DS} \ge 2 \times I_{\rm D} \times R_{\rm DS(on)max}, I_{\rm D} = 9.5 \ {\rm A}$	$g_{fs}$	8	14	_	S
Input capacitance $V_{\rm GS}$ = 0, $V_{\rm DS}$ = 25 V, $f$ = 1 MHz	$C_{iss}$	_	1200	1500	pF
Output capacitance $V_{\rm GS}$ = 0, $V_{\rm DS}$ = 25 V, $f$ = 1 MHz	$C_{ m oss}$	_	320	580	
Reverse transfer capacitance $V_{\rm GS}$ = 0, $V_{\rm DS}$ = 25 V, $f$ = 1 MHz	$C_{rss}$	_	160	260	
Turn-on time $t_{on}$ , $(t_{on} = t_{d(on)} + t_r)$	$t_{\sf d(on)}$	_	25	40	ns
$V_{\rm CC}$ = 30 V, $V_{\rm GS}$ = 5 V, $I_{\rm D}$ = 3 A, $R_{\rm GS}$ = 50 $\Omega$	t <sub>r</sub>	-	110	170	
Turn-off time $t_{\text{off}}$ , $(t_{\text{off}} = t_{\text{d(off)}} + t_{\text{f}})$	$t_{\sf d(off)}$		210	270	
$V_{\rm CC}$ = 30 V, $V_{\rm GS}$ = 5 V, $I_{\rm D}$ = 3 A, $R_{\rm GS}$ = 50 $\Omega$	t f		100	130	



# Electrical Characteristics (cont'd)

at  $T_{\rm j}$  = 25 °CC, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse Diode					
Continuous source current	$I_{\mathbb{S}}$			19	Α
Pulsed source current	I <sub>SM</sub>	_	_	76	
Diode forward on-voltage $I_{\rm F}$ = 38 A, $V_{\rm GS}$ = 0	$V_{SD}$	_	1.35	1.7	V
Reverse recovery time $I_F = I_S$ , $di_F/dt = 100 \text{ A/}\mu\text{s}$ , $V_R = 30 \text{ V}$	t <sub>rr</sub>	_	150	_	ns
Reverse recovery charge $I_F = I_S$ , $di_F/dt = 100$ A/ $\mu$ s, $V_R = 30$ V	$Q_{rr}$	_	0.58	_	μС
Temperature Sensor			·		
Forward voltage $I_{TS(on)} = 5 \text{ mA}, T_j = -55 \dots + 150 ^{\circ}\text{C}$ Sensor override, $t_p \le 100  \mu\text{s}$ $T_j = -55 \dots + 160 ^{\circ}\text{C}$	$V_{TS(on)}$	_	1.3	1.4	V
Forward current $T_{\rm j} = -55 \dots + 150  ^{\circ}{\rm C}$ Sensor override, $t_{\rm p} \le 100  \mu{\rm s}$ $T_{\rm j} = -55 \dots + 160  ^{\circ}{\rm C}$	$I_{TS(on)}$	-	_	5.0 600	mA
Holding current, $V_{\rm TS(off)} = 5$ V, $T_{\rm j} = 25$ °C $T_{\rm j} = 150$ °C	$I_{H}$	0.05 0.05	0.1 0.2	0.5 0.3	
Switching temperature $V_{TS} = 5 \text{ V}$	$T_{TS(on)}$	150	_	_	°C
Turn-off time $V_{TS} = 5 \text{ V}, I_{TS(on)} = 2 \text{ mA}$	$t_{ m off}$	0.5	_	2.5	μs



### **Examples for short-circuit protection**

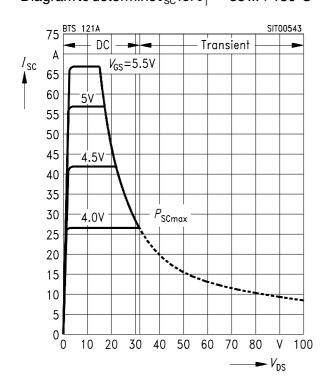
at  $T_{\rm j}$  = -55 ... + 150 °C, unless otherwise specified.

Parameter	Symbol	Examples			Unit
		1	2	_	
	1				
Drain-source voltage	$V_{ t DS}$	15	30	_	V
Gate-source voltage	$V_{GS}$	5.5	4.0	_	
Short-circuit current	$I_{ m SC}$	66.7	26.7	_	А
Short-circuit dissipation	$P_{ m SC}$	1000	800	_	W
Response time $T_i = 25 ^{\circ}\text{C}$ , before short circuit	$t_{ m SC(off)}$	≤ 25	≤ 25	_	ms

# Short-circuit protection $I_{SC} = f(V_{DS})$

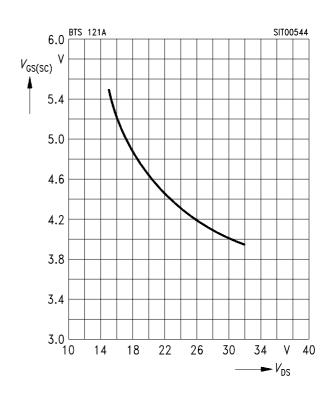
Parameter:  $V_{GS}$ 

Diagram to determine  $I_{SC}$  for  $T_i = -55 \dots + 150 ^{\circ}C$ 



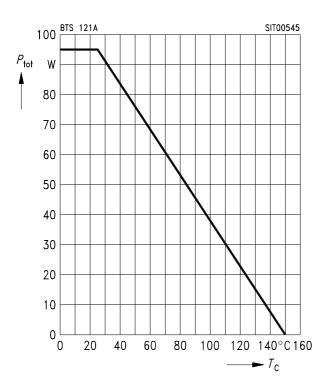
Max. gate voltage  $V_{\rm GS(SC)} = f(V_{\rm DS})$ 

Parameter:  $T_j = -55 \dots + 150 \,^{\circ}\text{C}$ 

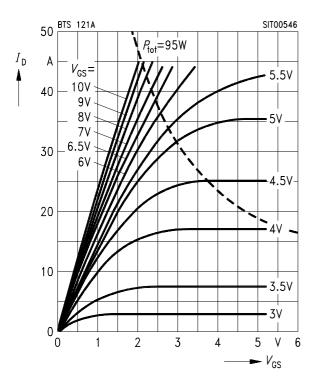




### Max. power dissipation $P_{\text{tot}} = f(T_{\text{C}})$



Typical output characteristics  $I_{\rm D}$  = f ( $V_{\rm DS}$ ) Parameter:  $t_{\rm p}$  = 80  $\mu {\rm s}$ 



### Typ. drain-source on-state resistance

 $R_{\mathrm{DS(on)}} = f(I_{\mathrm{D}})$ Parameter:  $V_{\mathrm{GS}}$  0.32  $R_{\mathrm{DS(on)}}$  0.24 0.24 0.12 0.08

5V 5.5V 6V 6.5V 7V 8V 9V 10V

16

24 A 28

**→** I<sub>D</sub>

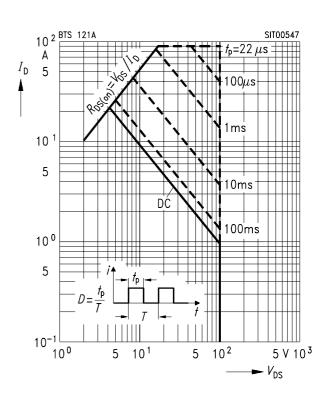
12

Safe operating area  $I_{\rm D}$  =  $f(V_{\rm DS})$ Parameter: D = 0.01,  $T_{\rm C}$  = 25 °C

8

0.04

0.00 [

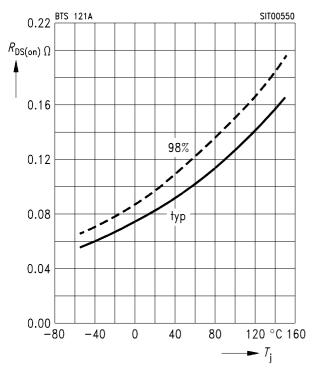




### **Drain-source on-state resistance**

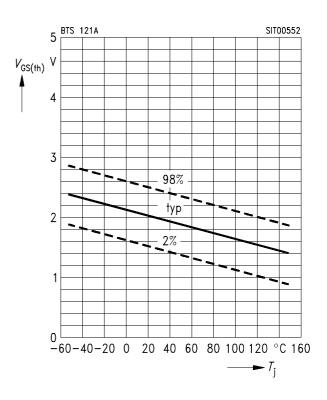
 $R_{\mathrm{DS(on)}} = f(T_{\mathrm{j}})$ 

Parameter:  $I_D$  = 4.5 A,  $V_{GS}$  = 9.5 V



## Gate threshold voltage $V_{GS(th)} = f(T_i)$

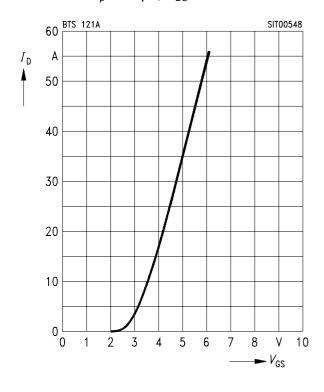
Parameter:  $V_{DS} = V_{GS}$ ,  $I_{D} = 1$  mA (spread)



## Typ. transfer characteristic

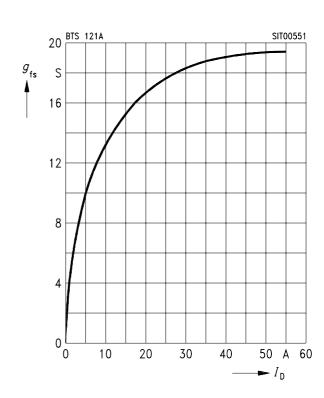
 $I_{\rm D} = f(V_{\rm GS})$ 

Parameter:  $t_p = 80 \mu s$ ,  $V_{DS} = 25 \text{ V}$ 



# Typ. transconductance $g_{fs} = f(I_D)$

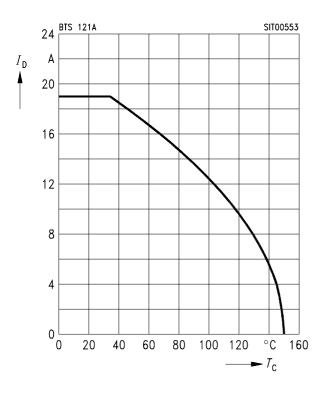
Parameter:  $t_{\rm p}$  = 80  $\mu$ s,  $V_{\rm DS}$  = 25 V





# Continuous drain current $I_{\rm D}$ = $f\left(T_{\rm C}\right)$

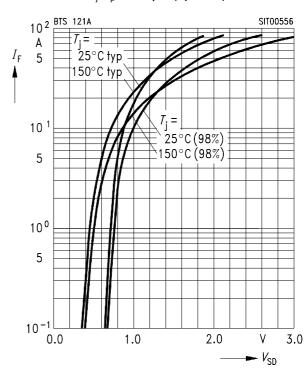
Parameter:  $V_{GS} \ge 10 \text{ V}$ 



### Forward characteristics of reverse diode

 $I_{\mathsf{F}} = f(V_{\mathsf{SD}})$ 

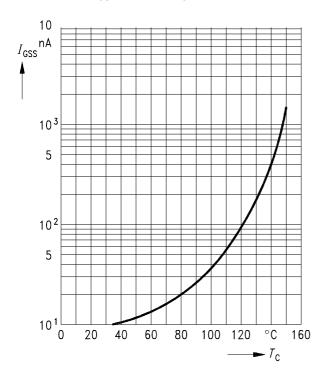
Parameter:  $T_{\rm j}$ ,  $t_{\rm p}$  = 80  $\mu s$  (spread)



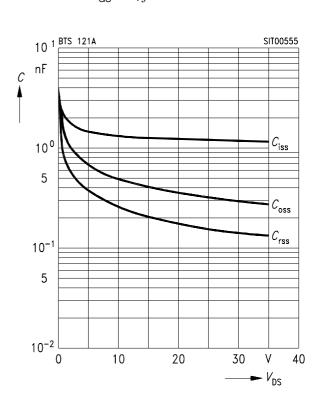
# Typ. gate-source leakage current

 $I_{\rm GSS} = f(T_{\rm C})$ 

Parameter:  $V_{GS} = 20 \text{ V}$ ,  $V_{DS} = 0$ 



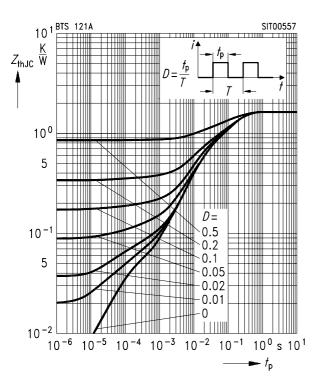
**Typ. capacitances**  $C = f(V_{DS})$  Parameter:  $V_{GS} = 0, f = 1$  MHz





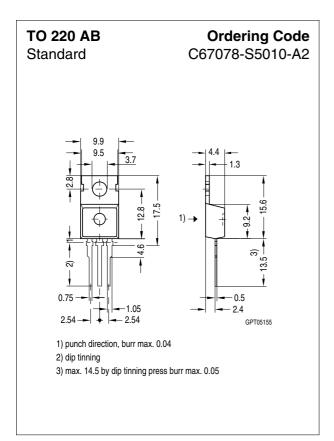
# Transient thermal impedance $Z_{\text{thJC}} = f(t_{\text{p}})$

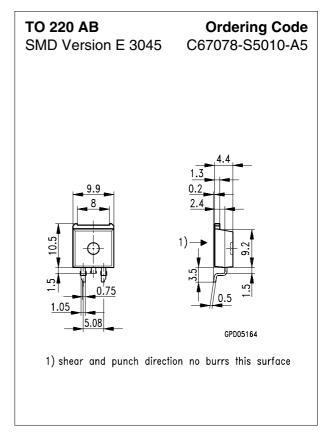
Parameter:  $D = t_p/T$ 











## TEMPFET® BTS 121 A



#### Edition 04.97

Published by Infineon Technologies AG, St.-Martin-Strasse 53, D-81541 München, Germany © Infineon Technologies AG 2000. All Rights Reserved.

### Attention please!

The information herein is given to describe certain components and shall not be considered as warranted characteristics.

Terms of delivery and rights to technical change reserved.

We hereby disclaim any and all warranties, including but not limited to warranties of non-infringement, regarding circuits, descriptions and charts stated herein.

Infineon Technologies is an approved CECC manufacturer.

#### Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office in Germany or our Infineon Technologies Representatives worldwide (see address list).

### Warnings

Due to technical requirements components may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies Office.

Infineon Technologies Components may only be used in life-support devices or systems with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system, or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body, or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.